

Time Delay | 0.063x0.032 inch Thick Film Chip Fuses

0603TD Series









0603TD Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.

Features

- High inrush current withstanding capability
- Ceramic and glass construction
- Halogen free, lead free and RoHS compliant
- Ultra high l²t values
- Excellent environmental integrity
- One time positive disconnect
- AEC-Q200 Automotive Grade Certified



- Flat panel displays and televisions
- Automotive infotainment and ECU
- Computer servers
- Portable electronics
- Mobile device chargers



Electrical Characteristics

Amp Rating	% of Amp Rating	Opening Time		
1~8A	100%	4 Hours Min.		
1~8A	200%	1~60 Seconds Max.		
1~8A	250%	5 Seconds Max.		

Specifications

Part Number	Ampere Rating (A)	Voltage Rating (V)	Interrupting Rating	Typical Cold Resistance (Ohms)	Typical Melting l ² t (A ² Sec)	Typical Voltage Drop (V)	Marking Code
0603TD-1A	1.00	32	32V@50A	0.250	0.011	0.335	В
0603TD-1.5A	1.50	32	32V@50A	0.150	0.045	0.270	Н
0603TD-2A	2.00	32	32V@50A	0.078	0.115	0.160	K
0603TD-2.5A	2.50	32	32V@50A	0.049	0.140	0.145	L
0603TD-3A	3.00	32	32V@50A	0.035	0.280	0.130	0
0603TD-3.5A	3.50	32	32V@50A	0.028	0.500	0.130	R
0603TD-4A	4.00	32	32V@50A	0.018	0.600	0.120	S
0603TD-5A	5.00	32	32V@50A	0.014	1.900	0.110	T
0603TD-6A	6.00	32	32V@50A	0.011	2.300	0.110	V**
0603TD-7A	7.00	32	32V@50A	0.0095	3.000	0.090	X**
0603TD-8A	8.00	32	32V@50A	0.0070	4.500	0.080	Z**

o DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)

o DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25degrees

o Typical Pre-arcing I2t are measured at 10ln Current.

Choice fuse for surge application (USB charger etc.), make sure the I²t of fuse is 4 times than surge.

^{**}Different with other ratings, the color of glass cover of 6A, 7A and 8A is BLUE color

Specifications are subject to change without notice. Application testing is strongly recommended.



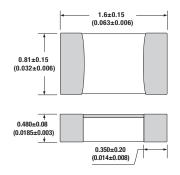
Time Delay | 0.063x0.032 inch

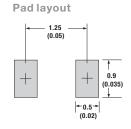
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Dimension

Unit: mm/inch

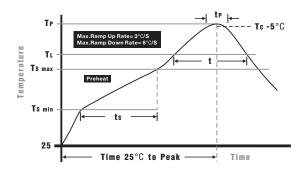




Packaging

- · Quantity: 5,000pcs
- 8mm wide tape on 178mm(7 inch) diameter reel -specification EIA Standard 481.

Soldering Parameters

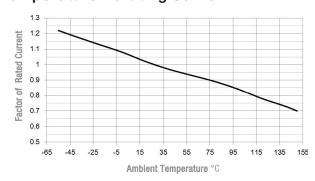


Wave Soldering: 260°C, 10 seconds max. Infrared Reflow: 260°C, 30 seconds max.

IR Reflow Profile

Preheat Heat Temperature min (Tsmin) Temperature max(Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60 -120 seconds			
Average ramp-up rate (Tsmax to Tp)	3°C/second max.			
Liquidous temperature (TL) Time at liquidous (tL)	217°C 60 - 150 seconds			
Peak temperature(Tp)	260+0/-5°C			
Time within 5°C of actual peak Temperature (tp)	10 – 30 seconds			
Average ramp-down rate (Tp to Tsmax)	6°C/second max.			
Time 25 °C to peak temperature	8 minutes max.			

Temperature Derating Curve



- $_{\circ}$ Normal ambient temperature: 23+/-3 $^{\circ}\mathrm{C}$
- o Operating temperature: -55 \sim 150 $^{\circ}$, with proper correction factor applied

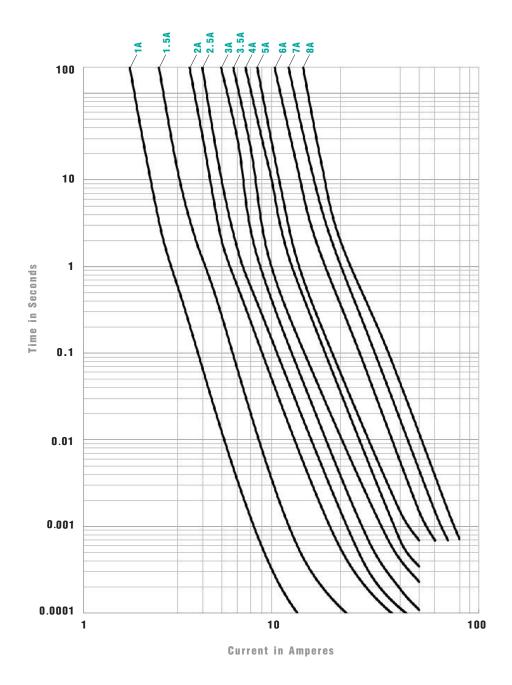


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Average Time Current Curves



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